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Dated: June 7, 2004

Signature:

(Raymond Garguilo, Jr.)

Docket No.: TESSERA 3.0-272  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Delin Li

Application No.: 10/611,390

: Group Art Unit: 2818

Filed: July 1, 2003

: Examiner: Mai Huong C.  
Tran

For: ASSEMBLIES HAVING STACKED  
SEMICONDUCTOR CHIPS AND METHODS  
OF MAKING SAME

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE**

Dear Sir:

In response to the Official Action mailed May 7, 2004, the applicant hereby elects Group I, namely claims 1-24, for examination in the present application. Applicant submits remarks to this election.